



# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## General Description

The MAX16016/MAX16020/MAX16021 supervisory circuits monitor power supplies, provide battery-backup control, and chip-enable (CE) gating to write protect memory in microprocessor ( $\mu$ P)-based systems. These low-power devices improve system reliability by providing several supervisory functions in a small, single integrated solution.

The MAX16016/MAX16020/MAX16021 perform four basic system functions:

- 1) Provide a  $\mu$ P reset output during  $V_{CC}$  supply power-up, power-down, and brownout conditions.
- 2) Control  $V_{CC}$  to battery-backup switching internally to maintain data or low-power operation for memories, real-time clocks (RTCs), and other digital logic when the main power is removed.
- 3) Provide memory write protection through internal chip-enable gating during brownout.
- 4) Provide a combination of additional supervisory functions listed in the *Features* section.

The MAX16016/MAX16020/MAX16021 operate from a 1.53V to 5.5V supply voltage and offer fixed reset thresholds for monitoring 5V, 3.3V, 3V, 2.5V, and 1.8V systems. Each device is available with either a push-pull or open-drain reset output.

The MAX16016/MAX16020/MAX16021 are available in small TDFN/TQFN packages and are fully specified for an operating temperature range of  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ .

## Applications

Main/Backup Power for RTCs, CMOS Memories  
Industrial Control  
GPS Systems  
Set-Top Boxes  
Point-of-Sale Equipment  
Portable/Battery Equipment

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## Features

- ◆ System Monitoring for 5V, 3.3V, 3V, 2.5V, or 1.8V Power-Supply Voltages
- ◆ 1.53V to 5.5V Operating Voltage Range
- ◆ Low 1.2 $\mu$ A Supply Current (0.25 $\mu$ A in Battery-Backup Mode)
- ◆ 145ms (min) Reset Timeout Period
- ◆ Battery Freshness Seal
- ◆ On-Board Gating of CE Signals, 1.5ns Propagation Delay (MAX16020/MAX16021)
- ◆ Debounced Manual Reset Input
- ◆ Watchdog Timer, 1.2s (typ) Timeout
- ◆ Power-Fail Comparator and Low-Line Indicator for Monitoring Voltages Down to 0.6V
- ◆ Battery-On, Battery-OK, and Battery Test Indicators
- ◆ Small 10-Pin TDFN or 16-Pin TQFN Packages
- ◆ UL<sup>®</sup>-Certified to Conform to IEC 60950-1

## Ordering Information

| PART           | TEMP RANGE                                     | PIN-PACKAGE |
|----------------|------------------------------------------------|-------------|
| MAX16016_TB_+T | $-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ | 10 TDFN-EP* |

The first placeholder “\_” designates all output options. Letter “L” indicates push-pull outputs and letter “P” indicates open-drain outputs. The last placeholder “\_” designates the reset threshold (see Table 1).

T = Tape and reel.

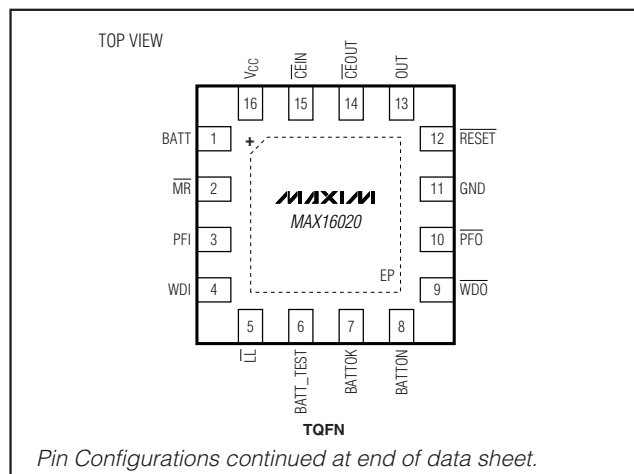
+ Denotes a lead(Pb)-free/RoHS-compliant package.

\*EP = Exposed pad.

Ordering Information continued at end of data sheet.

Selector Guide located at end of data sheet.

## Pin Configurations



MAX16016/MAX16020/MAX16021

# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## ABSOLUTE MAXIMUM RATINGS

$V_{CC}$ , BATT, OUT, BATT\_TEST to GND ..... -0.3V to +6V  
 RESET, RESET, PFO, BATTOK, WDO, BATTON,  
 BATT\_TEST, LL, (all open-drain) to GND ..... -0.3V to +6V  
 RESET, RESET, BATTOK, WDO, BATTON,  
 LL (all push-pull) to GND ..... -0.3V to ( $V_{OUT} + 0.3V$ )  
 WDI, PFI to GND ..... -0.3V to ( $V_{OUT} + 0.3V$ )  
 CEIN, CEOUT to GND ..... -0.3V to ( $V_{OUT} + 0.3V$ )  
 MR to GND ..... -0.3V to ( $V_{CC} + 0.3V$ )  
 Input Current  
 $V_{CC}$  Peak Current ..... 1A  
 $V_{CC}$  Continuous Current ..... 250mA  
 BATT Peak Current ..... 500mA  
 BATT Continuous Current ..... 70mA

Output Current  
 OUT Short Circuit to GND Duration ..... 10s  
 RESET, RESET, BATTON ..... 20mA  
 Continuous Power Dissipation ( $T_A = +70^\circ\text{C}$ )  
 10-Pin TDFN (derate 24.4mW/ $^\circ\text{C}$  above  $+70^\circ\text{C}$ ) ..... 1951mW  
 16-Pin TQFN (derate 25mW/ $^\circ\text{C}$  above  $+70^\circ\text{C}$ ) ..... 2000mW  
 Operating Temperature Range .....  $-40^\circ\text{C}$  to  $+85^\circ\text{C}$   
 Junction Temperature .....  $+150^\circ\text{C}$   
 Storage Temperature Range .....  $-65^\circ\text{C}$  to  $+150^\circ\text{C}$   
 Lead Temperature (soldering, 10s) .....  $+300^\circ\text{C}$   
 Soldering Temperature (reflow)  
 TDFN .....  $+260^\circ\text{C}$   
 TQFN .....  $+240^\circ\text{C}$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## PACKAGE THERMAL CHARACTERISTICS (Note 1)

TDFN

Junction-to Ambient Thermal Resistance ( $\theta_{JA}$ ) .....  $41^\circ\text{C}/\text{W}$   
 Junction-to Case Thermal Resistance ( $\theta_{JC}$ ) .....  $9^\circ\text{C}/\text{W}$

TQFN

Junction-to Ambient Thermal Resistance ( $\theta_{JA}$ ) .....  $40^\circ\text{C}/\text{W}$   
 Junction-to Case Thermal Resistance ( $\theta_{JC}$ ) .....  $6^\circ\text{C}/\text{W}$

**Note 1:** Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to [www.maxim-ic.com/thermal-tutorial](http://www.maxim-ic.com/thermal-tutorial).

## ELECTRICAL CHARACTERISTICS

( $V_{CC} = 1.53V$  to  $5.5V$ ,  $V_{BATT} = 3V$ ,  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ , unless otherwise noted. Typical values are at  $T_A = +25^\circ\text{C}$ .) (Note 2)

| PARAMETER                             | SYMBOL                | CONDITIONS                                                | MIN               | TYP                    | MAX | UNITS         |
|---------------------------------------|-----------------------|-----------------------------------------------------------|-------------------|------------------------|-----|---------------|
| Operating Voltage Range (Note 3)      | $V_{CC}$ , $V_{BATT}$ | $V_{CC}$ or $V_{BATT} > V_{TH}$                           | 0                 |                        | 5.5 | V             |
| Supply Current                        | $I_{CC}$              | $V_{CC} > V_{TH}$                                         |                   | $V_{CC} = 1.62V$       | 2   | $\mu\text{A}$ |
|                                       |                       |                                                           |                   | $V_{CC} = 2.8V$        | 3   |               |
|                                       |                       |                                                           |                   | $V_{CC} = 3.6V$        | 3.5 |               |
|                                       |                       |                                                           |                   | $V_{CC} = 5.5V$        | 5   |               |
| Supply Current in Battery-Backup Mode | $I_{BATT}$            | $V_{CC} = 0V$                                             |                   | 0.25                   | 0.5 | $\mu\text{A}$ |
| $V_{CC}$ Switchover Threshold Voltage |                       | $V_{CC}$ rising, $V_{CC} - V_{BATT}$                      |                   | 0.1<br>$\times V_{CC}$ |     | V             |
| BATT Switchover Threshold Voltage     |                       | $V_{CC}$ falling, $V_{CC} < V_{TH}$ , $V_{CC} - V_{BATT}$ |                   | 0                      |     | mV            |
| BATT Standby Current                  |                       | $V_{CC} > V_{BATT} + 0.2V$                                | -10               |                        | +10 | nA            |
| BATT Freshness Leakage Current        |                       | $V_{BATT} = 5.5V$                                         |                   |                        | 20  | nA            |
| $V_{CC}$ to OUT On-Resistance         | $R_{ON}$              | $V_{CC} = 4.75V$ , $I_{OUT} = 150mA$                      |                   | 1.4                    | 4.5 | $\Omega$      |
|                                       |                       | $V_{CC} = 3.15V$ , $I_{OUT} = 65mA$                       |                   | 1.7                    | 4.5 |               |
|                                       |                       | $V_{CC} = 2.35V$ , $I_{OUT} = 25mA$                       |                   | 2.1                    | 5.0 |               |
|                                       |                       | $V_{CC} = 1.91V$ , $I_{OUT} = 10mA$                       |                   | 2.6                    | 5.5 |               |
| Output Voltage in Battery-Backup Mode | $V_{OUT}$             | $V_{BATT} = 4.5V$ , $I_{OUT} = 20mA$                      | $V_{BATT} - 0.1$  |                        |     | V             |
|                                       |                       | $V_{BATT} = 2.5V$ , $I_{OUT} = 20mA$                      | $V_{BATT} - 0.15$ |                        |     |               |

# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

MAX16016/MAX16020/MAX16021

## ELECTRICAL CHARACTERISTICS (continued)

( $V_{CC} = 1.53V$  to  $5.5V$ ,  $V_{BATT} = 3V$ ,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .) (Note 2)

| PARAMETER                                        | SYMBOL   | CONDITIONS                                         | MIN           | TYP   | MAX   | UNITS |
|--------------------------------------------------|----------|----------------------------------------------------|---------------|-------|-------|-------|
| RESET OUTPUT (RESET, RESET)                      |          |                                                    |               |       |       |       |
| Reset Threshold                                  | VTH      |                                                    | (see Table 1) |       |       | V     |
| VCC Falling to Reset Delay                       | tRD      | VCC falling at 10V/ms                              | 20            |       |       | μs    |
| Reset Timeout Period                             | tRP      |                                                    | 145           | 215   | 285   | ms    |
| RESET Output Low Voltage                         | VOL      | VCC ≥ 3.3V, ISINK = 3.2mA, RESET asserted          | 0.3           |       |       | V     |
|                                                  |          | VCC ≥ 1.6V, ISINK = 1mA, RESET asserted            | 0.3           |       |       |       |
|                                                  |          | VCC ≥ 1.2V, ISINK = 100μA, RESET asserted          | 0.3           |       |       |       |
| RESET Output High Voltage (Push-Pull Output)     | VOH      | VCC = 1.1 x VTH, ISOURCE = 100μA, RESET deasserted | VOUT - 0.3    |       |       | V     |
| RESET Output Leakage Current (Open-Drain Output) |          | VRESET = 5.5V, RESET deasserted                    | 1             |       |       | μA    |
| RESET Output Low Voltage                         | VOL      | VCC ≥ 3.3V, ISINK = 3.2mA, RESET deasserted        | 0.3           |       |       | V     |
|                                                  |          | VCC ≥ 1.8V, ISINK = 1.0mA, RESET deasserted        | 0.3           |       |       |       |
| RESET Output High Voltage (Push-Pull Output)     | VOH      | VCC = 0.9 x VTH, ISOURCE = 100μA, RESET asserted   | VOUT - 0.3    |       |       | V     |
| RESET Output Leakage Current (Open-Drain Output) |          | VRESET = 5.5V, RESET asserted                      | 1             |       |       | μA    |
| POWER-FAIL COMPARATOR                            |          |                                                    |               |       |       |       |
| PFI, Input Threshold                             | VPFT     | VIN falling, 1.6V ≤ VCC ≤ 5.5V                     | 0.572         | 0.590 | 0.611 | V     |
| PFI, Hysteresis                                  | VPFT-HYS |                                                    | 30            |       |       | mV    |
| PFI Input Current                                |          | VCC = 5.5V                                         | -1            |       | +1    | μA    |
| PFO Output Low Voltage                           | VOL      | VCC ≥ 1.6V, ISINK = 1mA, output asserted           | 0.3           |       |       | V     |
|                                                  |          | VCC ≥ 1.2V, ISINK = 100μA, output asserted         | 0.3           |       |       |       |
| PFO Output Voltage High (Push-Pull Output)       | VOH      | VCC = 1.1 x VTH, ISOURCE = 100μA, output asserted  | VOUT - 0.3    |       |       | V     |
| PFO, Leakage Current (Open-Drain Output)         |          | VPFO = 5.5V, output deasserted                     | 1             |       |       | μA    |
| PFO, Delay Time                                  |          | VPFT + 100mV to VPFT - 100mV                       | 20            |       |       | μs    |
| MANUAL RESET (MR)                                |          |                                                    |               |       |       |       |
| Input Low Voltage                                | VIL      |                                                    | 0.3 x VCC     |       |       | V     |
| Input High Voltage                               | VIH      |                                                    | 0.7 x VCC     |       |       | V     |
| Pullup Resistance                                |          |                                                    | 20            | 30    |       | kΩ    |
| Glitch Immunity                                  |          | VCC = 3.3V                                         | 100           |       |       | ns    |
| MR to Reset Delay                                |          |                                                    | 120           |       |       | ns    |

# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## ELECTRICAL CHARACTERISTICS (continued)

( $V_{CC} = 1.53V$  to  $5.5V$ ,  $V_{BATT} = 3V$ ,  $T_A = -40^\circ C$  to  $+85^\circ C$ , unless otherwise noted. Typical values are at  $T_A = +25^\circ C$ .) (Note 2)

| PARAMETER                                                                      | SYMBOL    | CONDITIONS                                                                           | MIN                 | TYP   | MAX                 | UNITS    |
|--------------------------------------------------------------------------------|-----------|--------------------------------------------------------------------------------------|---------------------|-------|---------------------|----------|
| <b>WATCHDOG TIMER (WDI, WDO)</b>                                               |           |                                                                                      |                     |       |                     |          |
| Watchdog Timeout Period                                                        | $t_{WD}$  |                                                                                      | 0.83                | 1.235 | 1.64                | s        |
| Minimum WDI Input Pulse Width                                                  | $t_{WDI}$ |                                                                                      | 320                 |       |                     | ns       |
| WDI Input Low Voltage                                                          | $V_{IL}$  | (Note 6)                                                                             |                     |       | $0.3 \times V_{CC}$ | V        |
| WDI Input High Voltage                                                         | $V_{IH}$  | (Note 6)                                                                             | $0.7 \times V_{CC}$ |       |                     | V        |
| WDI Input Current (Note 7)                                                     |           | $V_{WDI} = 0V$ or $5.5V$ , time average                                              | -1                  |       | +1                  | $\mu A$  |
| $\overline{WDO}$ Output Low Voltage                                            | $V_{OL}$  | $V_{CC} = 5.0V$ , $I_{SINK} = 1mA$ , $\overline{WDO}$ asserted                       |                     |       | 0.3                 | V        |
| $\overline{WDO}$ Output High Voltage (Push-Pull Output)                        | $V_{OH}$  | $V_{CC} = 1.1 \times V_{TH}$ , $I_{SOURCE} = 100\mu A$ , $\overline{WDO}$ deasserted | $V_{OUT} - 0.3$     |       |                     | V        |
| $\overline{WDO}$ Leakage Current (Open-Drain Output)                           |           | $V_{\overline{WDO}} = 5.5V$ , $\overline{WDO}$ deasserted                            |                     |       | 1                   | $\mu A$  |
| <b>BATTERY-ON INDICATOR (BATTON)</b>                                           |           |                                                                                      |                     |       |                     |          |
| Output Low Voltage                                                             | $V_{OL}$  | $I_{SINK} = 3.2mA$ , $V_{BATT} = 2.1V$                                               |                     |       | 0.3                 | V        |
| BATTON Leakage Current                                                         |           | $V_{BATTON} = 5.5V$                                                                  |                     |       | 1                   | $\mu A$  |
| BATTON Output High Voltage                                                     | $V_{OH}$  | $V_{CC} = 0.9 \times V_{TH}$ , $I_{SOURCE} = 100\mu A$ , BATTON asserted             | $V_{OUT} - 0.3$     |       |                     | V        |
| Output Short-Circuit Current (Note 4)                                          |           | Sink current, $V_{CC} = 5V$                                                          |                     | 60    |                     | mA       |
| <b>CE GATING (<math>\overline{CEIN}</math>, <math>\overline{CEOUT}</math>)</b> |           |                                                                                      |                     |       |                     |          |
| $\overline{CEIN}$ Leakage Current                                              |           | Reset asserted, $V_{CC} = 0.9 \times V_{TH}$ or $0V$                                 | -1                  |       | +1                  | $\mu A$  |
| $\overline{CEIN}$ to $\overline{CEOUT}$ Resistance                             |           | Reset not asserted (Note 5)                                                          |                     | 8     | 50                  | $\Omega$ |
| $\overline{CEOUT}$ Short-Circuit Current                                       |           | Reset asserted, $\overline{CEOUT} = 0$ , $V_{CC} = 0.9 \times V_{TH}$                |                     | 0.75  | 2                   | mA       |
| $\overline{CEIN}$ to $\overline{CEOUT}$ Propagation Delay                      |           | $50\Omega$ source, $C_{LOAD} = 50pF$ , $V_{CC} = 4.75V$                              |                     | 1.5   | 7                   | ns       |
| Output High Voltage                                                            |           | $V_{CC} = 5V$ , $V_{CC} \geq V_{BATT}$ , $I_{SOURCE} = 100\mu A$                     | $0.8 \times V_{CC}$ |       |                     | V        |
|                                                                                |           | $V_{CC} = 0V$ , $V_{BATT} \geq 2.2V$ , $I_{SOURCE} = 1\mu A$                         | $V_{BATT} - 0.1$    |       |                     |          |
| Reset to $\overline{CEOUT}$ Delay                                              |           |                                                                                      |                     | 12    |                     | $\mu s$  |

# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## ELECTRICAL CHARACTERISTICS (continued)

( $V_{CC} = 1.53V$  to  $5.5V$ ,  $V_{BATT} = 3V$ ,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .) (Note 2)

| PARAMETER                                              | SYMBOL          | CONDITIONS                                                                                                                   | MIN                    | TYP | MAX   | UNITS |
|--------------------------------------------------------|-----------------|------------------------------------------------------------------------------------------------------------------------------|------------------------|-----|-------|-------|
| LOW LINE ( $\overline{LL}$ )                           |                 |                                                                                                                              |                        |     |       |       |
| Low Line to Reset Threshold Voltage                    |                 | V <sub>CC</sub> falling                                                                                                      | (see Table 2)          |     |       | mV    |
| V <sub>CC</sub> Falling to $\overline{LL}$ Delay       |                 | V <sub>CC</sub> falling at 10V/ms                                                                                            | 20                     |     |       | μs    |
| $\overline{LL}$ Output Low Voltage                     | V <sub>OL</sub> | V <sub>CC</sub> ≥ 1.6V, I <sub>SINK</sub> = 1mA, $\overline{LL}$ asserted                                                    | 0.3                    |     |       | V     |
|                                                        |                 | V <sub>CC</sub> ≥ 1.2V, I <sub>SINK</sub> = 100μA, $\overline{LL}$ asserted                                                  | 0.3                    |     |       |       |
| $\overline{LL}$ Output High Voltage (Push-Pull Output) | V <sub>OH</sub> | V <sub>CC</sub> = 0.9 x V <sub>TH,<math>\overline{LL}</math></sub> , I <sub>SOURCE</sub> = 100μA, $\overline{LL}$ deasserted | V <sub>OUT</sub> - 0.3 |     |       | V     |
| Output Leakage Current                                 |                 | V $\overline{LL}$ = 5.5V, $\overline{LL}$ deasserted                                                                         | 1                      |     |       | μA    |
| BATTERY-OK INDICATOR (BATTOK, BATT_TEST)               |                 |                                                                                                                              |                        |     |       |       |
| BATTOK Threshold                                       |                 | Inferred internally from BATT                                                                                                | 2.508                  | 2.6 | 2.673 | V     |
| BATTOK Output Voltage Low                              | V <sub>OL</sub> | V <sub>CC</sub> = 1.1 x V <sub>TH</sub> , I <sub>SINK</sub> = 1mA, reset asserted                                            | 0.3                    |     |       | V     |
| BATTOK Output High Voltage                             | V <sub>OH</sub> | V <sub>CC</sub> = 1.1 x V <sub>TH</sub> , I <sub>SOURCE</sub> = 100μA, BATTOK asserted                                       | V <sub>OUT</sub> - 0.3 |     |       | V     |
| BATTOK Output Leakage Current                          |                 | V <sub>BATTOK</sub> = 5.5V, deasserted                                                                                       | 1                      |     |       | μA    |
| BATT_TEST Output Low Voltage                           |                 | V <sub>CC</sub> = 1.1 x V <sub>TH</sub> , I <sub>SINK</sub> = 1mA                                                            | 0.3                    |     |       | V     |

**Note 2:** All devices are 100% production tested at  $T_A = +25^{\circ}C$  and  $T_A = +85^{\circ}C$ . Limits to  $-40^{\circ}C$  are guaranteed by design.

**Note 3:**  $V_{BATT}$  can be 0V anytime, or  $V_{CC}$  can go down to 0V if  $V_{BATT}$  is active (except at startup).

**Note 4:** Use external current-limit resistor to limit current to 20mA (max).

**Note 5:**  $\overline{CEIN}/\overline{CEOUT}$  resistance is tested with  $V_{CC} = 5V$  and  $V_{\overline{CEIN}} = 0V$  or  $5V$ .

**Note 6:** WDI is internally serviced within the watchdog period if WDI is left unconnected.

**Note 7:** The WDI input current is specified as the average input current when the WDI input is driven high or low. The WDI input is designed for a three-stated output device with a 10 $\mu A$  maximum leakage current and capable of driving a maximum capacitive load of 200pF. The three-state device must be able to source and sink at least 200 $\mu A$  when active.

**Table 1a. Reset Threshold Ranges (MAX16016)**

| SUFFIX | RESET THRESHOLD RANGES (V) |       |       |
|--------|----------------------------|-------|-------|
|        | MIN                        | TYP   | MAX   |
| L      | 4.508                      | 4.63  | 4.906 |
| M      | 4.264                      | 4.38  | 4.635 |
| T      | 2.991                      | 3.08  | 3.239 |
| S      | 2.845                      | 2.93  | 3.080 |
| R      | 2.549                      | 2.63  | 2.755 |
| Z      | 2.243                      | 2.32  | 2.425 |
| Y      | 2.117                      | 2.19  | 2.288 |
| W      | 1.603                      | 1.67  | 1.733 |
| V      | 1.514                      | 1.575 | 1.639 |

**Table 1b. Reset Threshold Ranges (MAX16020/MAX16021)**

| SUFFIX | RESET THRESHOLD RANGES (V) |       |       |
|--------|----------------------------|-------|-------|
|        | MIN                        | TYP   | MAX   |
| L      | 4.520                      | 4.684 | 4.852 |
| M      | 4.275                      | 4.428 | 4.585 |
| T      | 3.010                      | 3.100 | 3.190 |
| S      | 2.862                      | 2.946 | 3.034 |
| R      | 2.568                      | 2.640 | 2.716 |
| Z      | 2.260                      | 2.323 | 2.390 |
| Y      | 2.133                      | 2.192 | 2.255 |
| W      | 1.616                      | 1.661 | 1.710 |
| V      | 1.528                      | 1.571 | 1.618 |

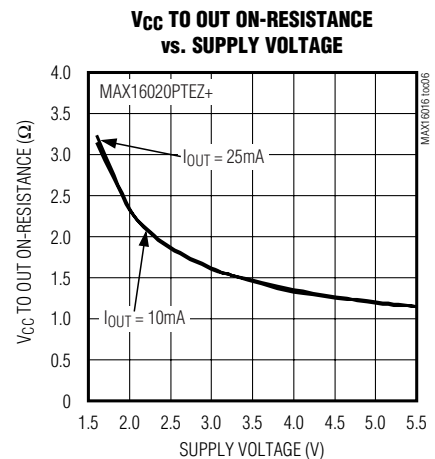
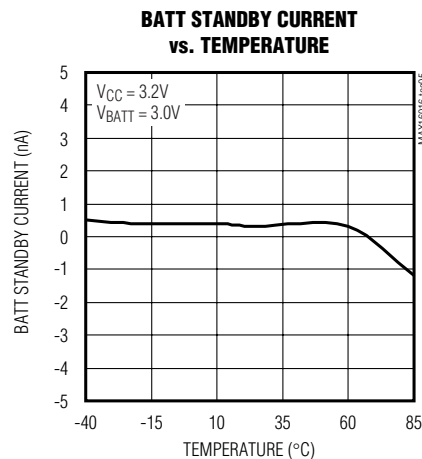
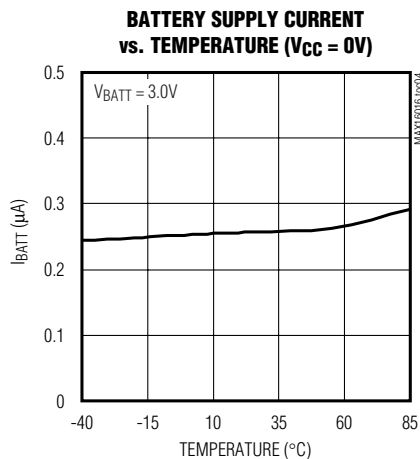
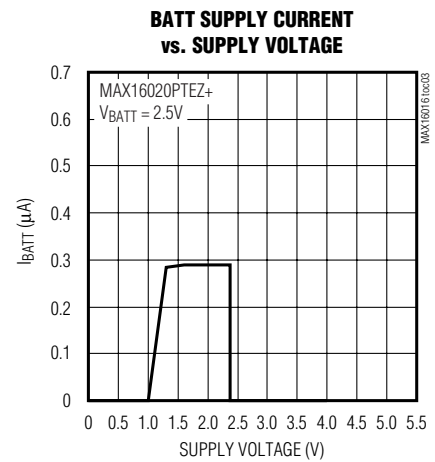
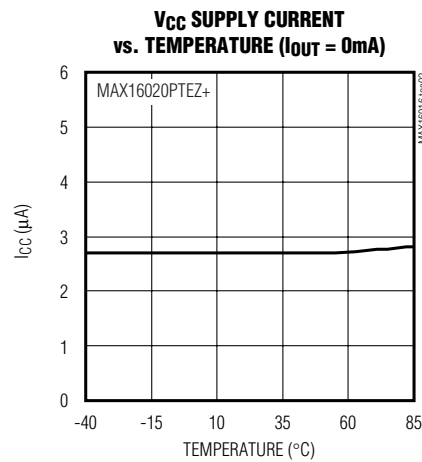
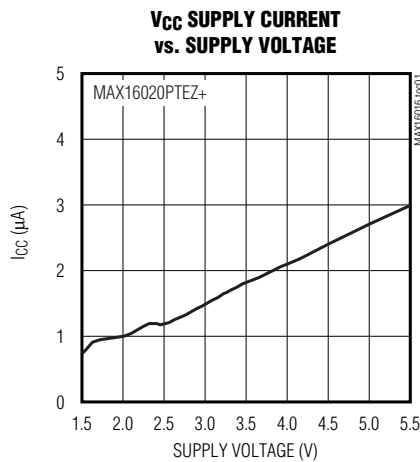
# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

Table 2. Low-Line Threshold Ranges

| SUFFIX | LOW-LINE THRESHOLD RANGES (V) |       |       |
|--------|-------------------------------|-------|-------|
|        | MIN                           | TYP   | MAX   |
| L      | 4.627                         | 4.806 | 4.955 |
| M      | 4.378                         | 4.543 | 4.683 |
| T      | 3.075                         | 3.181 | 3.274 |
| S      | 2.922                         | 3.023 | 3.111 |
| R      | 2.620                         | 2.409 | 2.787 |
| Z      | 2.309                         | 2.383 | 2.450 |
| Y      | 2.180                         | 2.246 | 2.311 |
| W      | 1.653                         | 1.704 | 1.752 |
| V      | 1.563                         | 1.612 | 1.657 |

## Typical Operating Characteristics

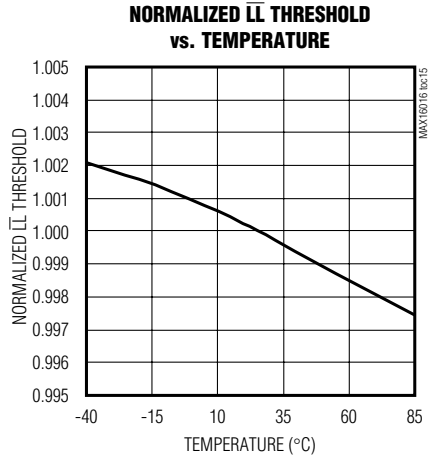
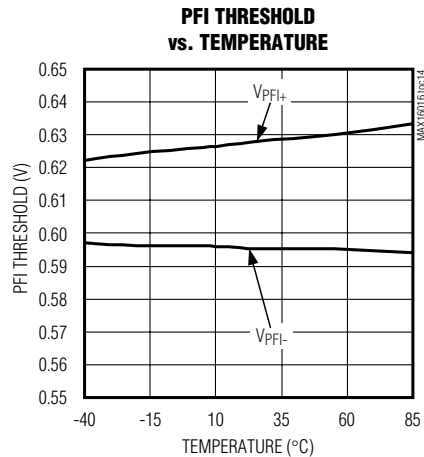
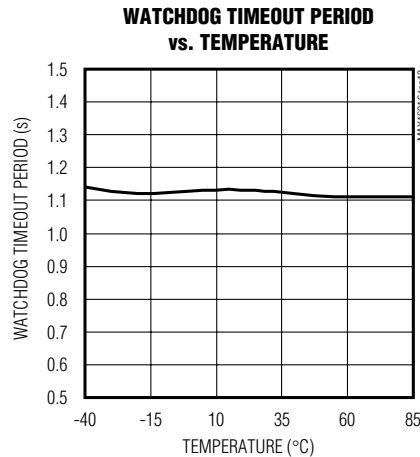
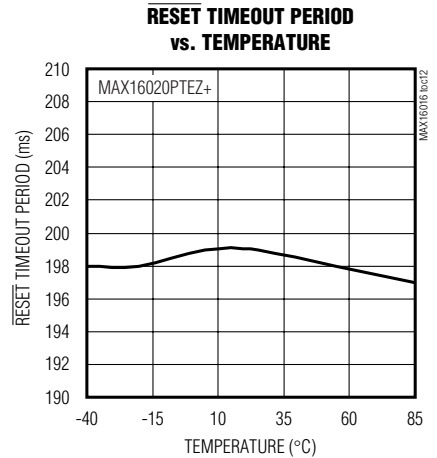
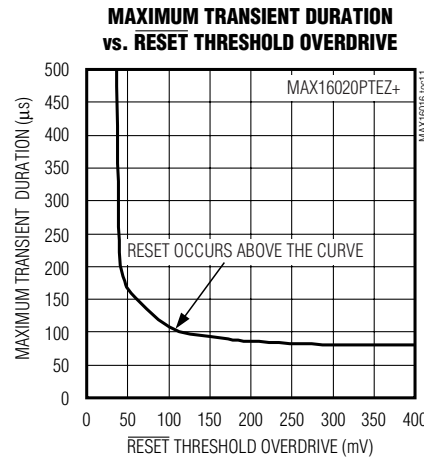
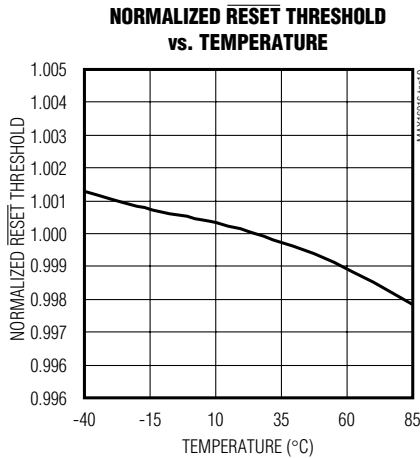
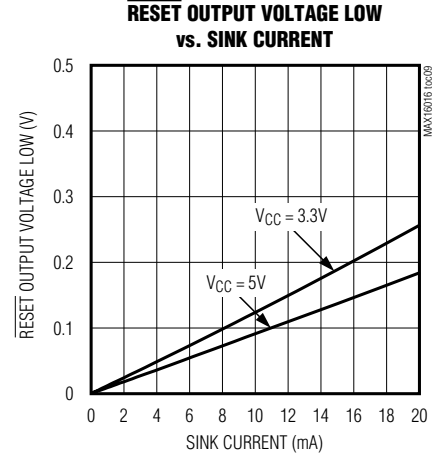
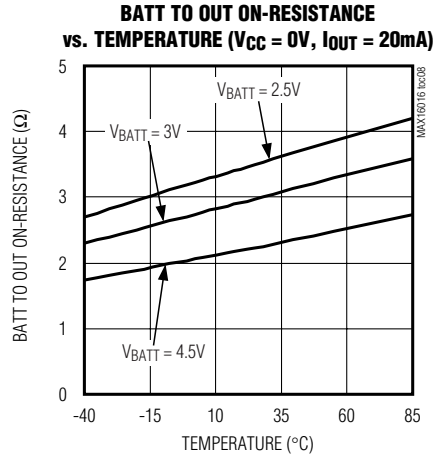
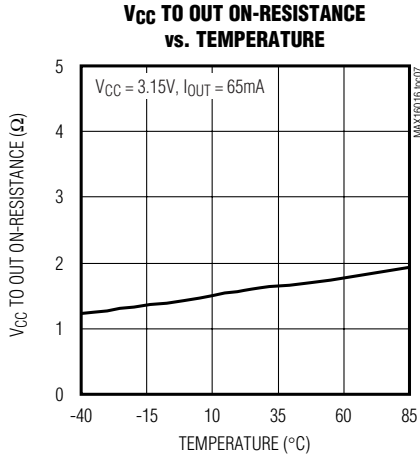
( $V_{CC} = 5V$ ,  $V_{BATT} = 0V$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)



# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## Typical Operating Characteristics (continued)

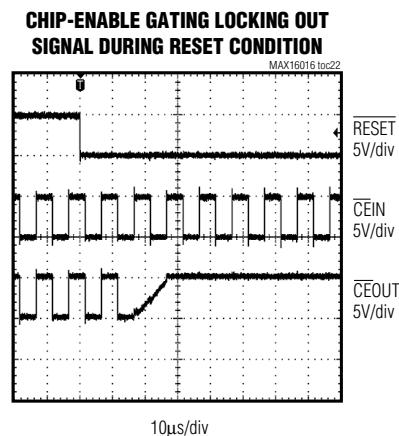
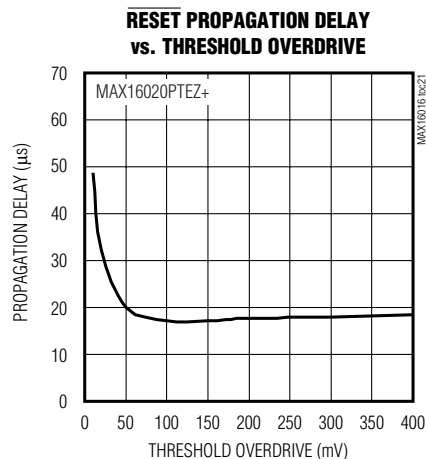
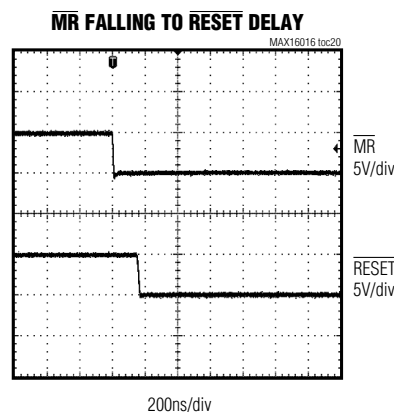
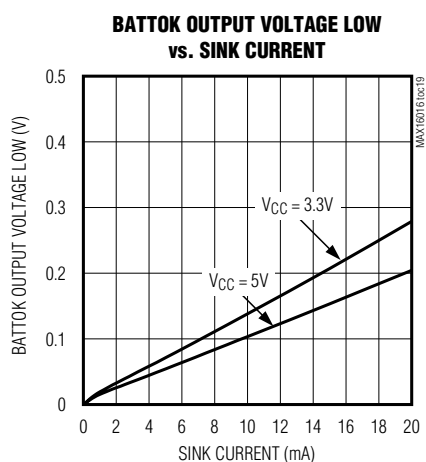
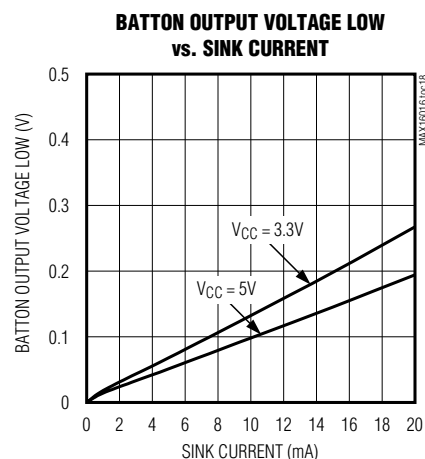
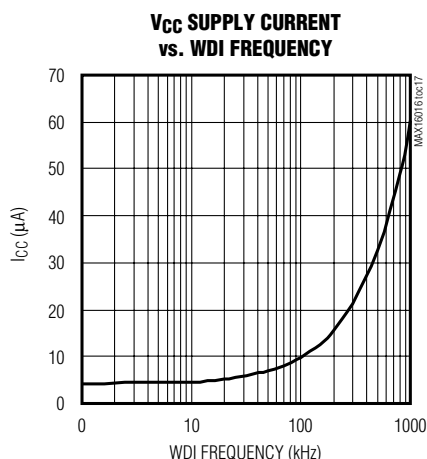
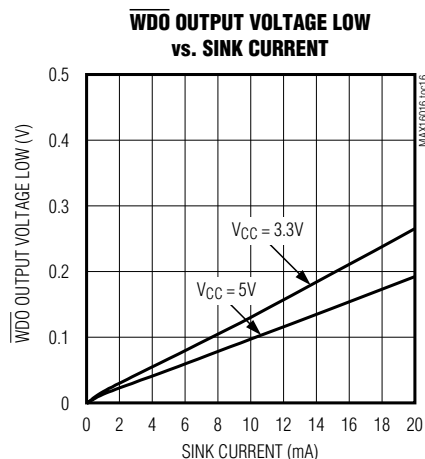
( $V_{CC} = 5V$ ,  $V_{BATT} = 0V$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)



# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## Typical Operating Characteristics (continued)

( $V_{CC} = 5V$ ,  $V_{BATT} = 0V$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)





# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## Pin Description—MAX16016

| PIN | NAME                      | FUNCTION                                                                                                                                                                                                                                                                                                                                                                                                                    |
|-----|---------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1   | VCC                       | Supply Voltage Input. Bypass VCC to GND with a 0.1 $\mu$ F capacitor.                                                                                                                                                                                                                                                                                                                                                       |
| 2   | BATT                      | Backup Battery Input. If VCC falls below its reset threshold, and if VBATT > VCC, OUT connects to BATT. If VCC rises above 1.01 x VBATT, OUT connects to VCC. Bypass BATT to GND with a 0.1 $\mu$ F capacitor.                                                                                                                                                                                                              |
| 3   | $\overline{\text{MR}}$    | Active-Low Manual Reset Input. $\overline{\text{RESET}}$ asserts when $\overline{\text{MR}}$ is pulled low. $\overline{\text{RESET}}$ remains low for the duration of reset timeout period after $\overline{\text{MR}}$ transitions from low to high. Connect $\overline{\text{MR}}$ to VCC or leave unconnected if not used. $\overline{\text{MR}}$ is internally connected to VCC through a 30k $\Omega$ pullup resistor. |
| 4   | PFI                       | Power-Fail Comparator Input. Connect PFI to a resistive divider to set the desired PFI threshold. The PFI input is referenced to an internal VPFT threshold. A VPFT-HYS internal hysteresis provides noise immunity. The power-fail comparator is powered from OUT.                                                                                                                                                         |
| 5   | WDI                       | Watchdog Timer Input. If WDI remains high or low for longer than the watchdog timeout period (t <sub>WD</sub> ), the internal watchdog timer runs out and a reset pulse is triggered for the reset timeout period. The internal watchdog clears when reset asserts or whenever WDI sees a rising or falling edge. To disable the watchdog feature, leave WDI unconnected or three-state the driver connected to WDI.        |
| 6   | BATTON                    | Active-High Battery-On Output. BATTON goes high when in battery-backup mode.                                                                                                                                                                                                                                                                                                                                                |
| 7   | $\overline{\text{PFO}}$   | Active-Low Power-Fail Comparator Output. $\overline{\text{PFO}}$ goes low when VPFI falls below the internal VPFT threshold and goes high when VPFI rises above VPFT + VPFT-HYS hysteresis.                                                                                                                                                                                                                                 |
| 8   | GND                       | Ground                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 9   | $\overline{\text{RESET}}$ | Active-Low Reset Output. $\overline{\text{RESET}}$ asserts when VCC falls below the reset threshold or $\overline{\text{MR}}$ is pulled low. $\overline{\text{RESET}}$ remains low for the duration of the reset timeout period after VCC rises above the reset threshold and $\overline{\text{MR}}$ goes high. $\overline{\text{RESET}}$ also asserts low when the internal watchdog timer runs out.                       |
| 10  | OUT                       | Switched Output. OUT is connected to VCC when the reset output is not asserted or when VCC is greater than VBATT. OUT connects to BATT when $\overline{\text{RESET}}$ is asserted and VBATT is greater than VCC. Bypass OUT to GND with a 0.1 $\mu$ F (min) capacitor.                                                                                                                                                      |

MAX16016/MAX16020/MAX16021

# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## Pin Description—MAX16020/MAX16021

| PIN      |          | NAME                   | FUNCTION                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|----------|----------|------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| MAX16020 | MAX16021 |                        |                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| 1        | 1        | BATT                   | Backup Battery Input. If $V_{CC}$ falls below its reset threshold, and if $V_{BATT} > V_{CC}$ , OUT connects to BATT. If $V_{CC}$ rises above $1.01 \times V_{BATT}$ , OUT connects to $V_{CC}$ . Bypass BATT to GND with a $0.1\mu\text{F}$ capacitor.                                                                                                                                                                                     |
| 2        | 2        | $\overline{\text{MR}}$ | Active-Low Manual Reset Input. $\overline{\text{RESET}}$ asserts when $\overline{\text{MR}}$ is pulled low. $\overline{\text{RESET}}$ remains low for the duration of reset timeout period after $\overline{\text{MR}}$ transitions from low to high. Connect $\overline{\text{MR}}$ to $V_{CC}$ or leave unconnected if not used. $\overline{\text{MR}}$ is internally connected to $V_{CC}$ through a $30\text{k}\Omega$ pullup resistor. |
| 3        | 3        | PFI                    | Power-Fail Comparator Input. Connect PFI to a resistive divider to set the desired PFI threshold. The PFI input is referenced to an internal threshold $V_{PFT}$ , $V_{PFT-HYS}$ internal hysteresis provides noise immunity. The power-fail comparator is powered from OUT.                                                                                                                                                                |
| 4        | 4        | WDI                    | Watchdog Timer Input. If WDI remains high or low for longer than the watchdog timeout period ( $t_{WD}$ ), the internal watchdog timer runs out and asserts $\overline{\text{WDO}}$ . The internal watchdog clears when reset asserts or whenever WDI sees a rising or falling edge. To disable the watchdog feature, leave WDI unconnected or three-state the driver connected to WDI.                                                     |
| 5        | 5        | $\overline{\text{LL}}$ | Active-Low Low-Line Output. $\overline{\text{LL}}$ goes low when $V_{CC}$ falls to 2.5% above the reset threshold (Table 2). $\overline{\text{LL}}$ provides an early warning of $V_{CC}$ failure before reset asserts. Use this output to generate a nonmaskable interrupt (NMI) to initiate an orderly shutdown routine when $V_{CC}$ is falling.                                                                                         |
| 6        | —        | BATT_TEST              | Open-Drain Battery-Test Output. Pulses low for 1.3s every 24 hours during the battery voltage test. If $V_{BATT} < 2.6\text{V}$ , BATTOK deasserts low. See Figure 6 for providing additional load during the battery test.                                                                                                                                                                                                                 |
| —        | 6        | RESET                  | Active-High Reset Output. RESET asserts when $V_{CC}$ falls below the reset threshold or when $\overline{\text{MR}}$ asserts and stays asserted for the reset timeout period after $V_{CC}$ rises above the reset threshold and $\overline{\text{MR}}$ deasserts.                                                                                                                                                                           |
| 7        | 7        | BATTOK                 | Battery-OK Output. BATTOK goes low when the battery voltage falls below the BATTOK threshold (BATTOK is low when in battery-backup mode).                                                                                                                                                                                                                                                                                                   |
| 8        | 8        | BATTON                 | Active-High Battery-On Output. BATTON goes high when in battery-backup mode.                                                                                                                                                                                                                                                                                                                                                                |

# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

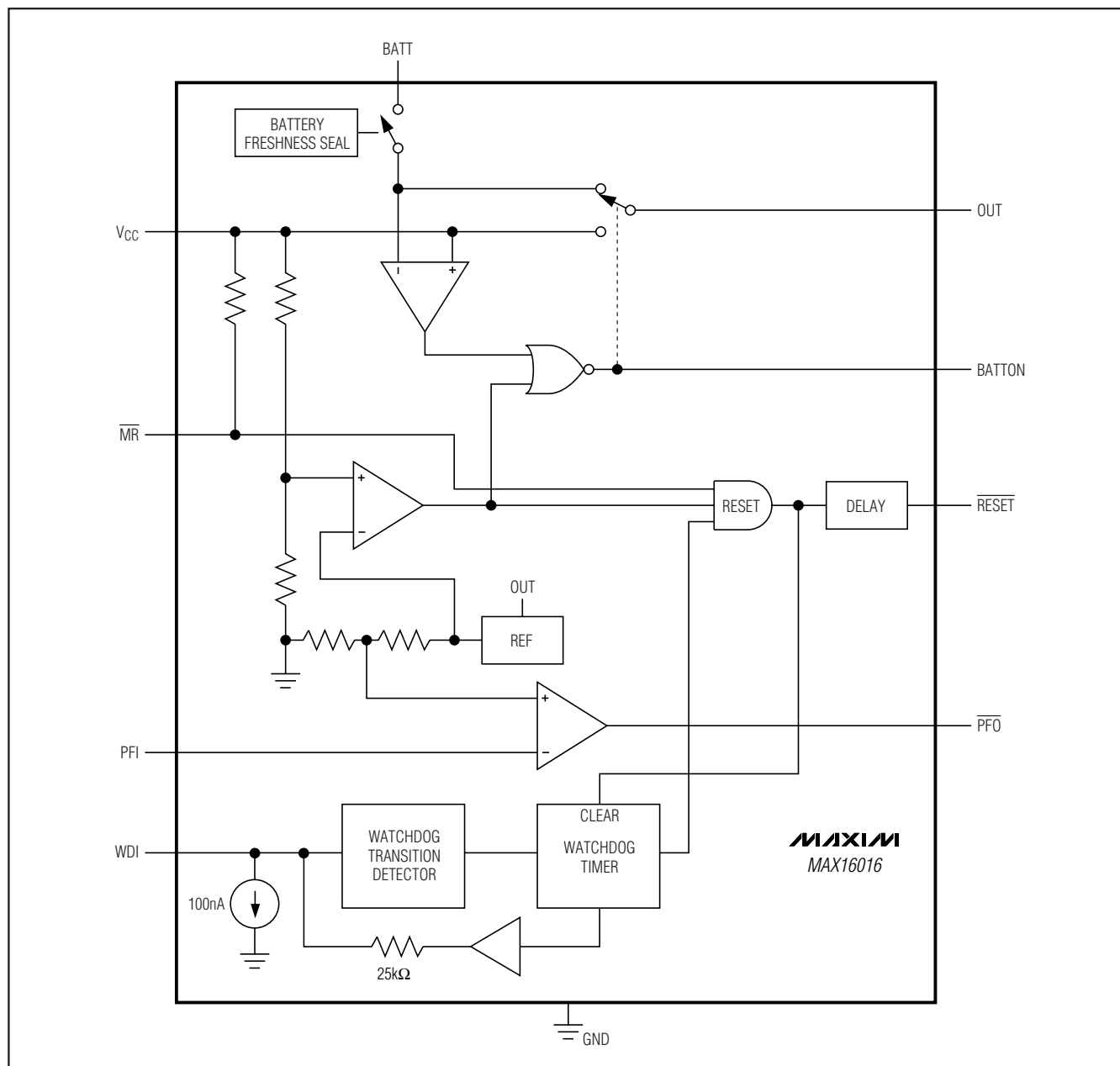
## Pin Description—MAX16020/MAX16021 (continued)

| PIN      |          | NAME                      | FUNCTION                                                                                                                                                                                                                                                                                                                                |
|----------|----------|---------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| MAX16020 | MAX16021 |                           |                                                                                                                                                                                                                                                                                                                                         |
| 9        | 9        | $\overline{\text{WDO}}$   | Active-Low Watchdog Output. $\overline{\text{WDO}}$ asserts when WDI remains high or low longer than the watchdog timeout period. $\overline{\text{WDO}}$ returns high on the next WDI transition or when a reset is asserted.                                                                                                          |
| 10       | 10       | $\overline{\text{PFO}}$   | Active-Low Power-Fail Comparator Output. $\overline{\text{PFO}}$ goes low when $V_{\text{PFI}}$ falls below the internal 0.6V $V_{\text{PFT}}$ threshold and goes high when $V_{\text{PFI}}$ rises above $V_{\text{PFT}} + V_{\text{PFT-HYS}}$ hysteresis.                                                                              |
| 11       | 11       | GND                       | Ground                                                                                                                                                                                                                                                                                                                                  |
| 12       | 12       | $\overline{\text{RESET}}$ | Active-Low Reset Output. $\overline{\text{RESET}}$ asserts when $V_{\text{CC}}$ falls below the reset threshold or $\overline{\text{MR}}$ is pulled low. $\overline{\text{RESET}}$ remains low for the duration of the reset timeout period after $V_{\text{CC}}$ rises above the reset threshold and $\overline{\text{MR}}$ goes high. |
| 13       | 13       | OUT                       | Switched Output. OUT is connected to $V_{\text{CC}}$ when the reset output is not asserted or when $V_{\text{CC}}$ is greater than $V_{\text{BATT}}$ . OUT connects to BATT when $\overline{\text{RESET}}$ is asserted and $V_{\text{BATT}}$ is greater than $V_{\text{CC}}$ . Bypass OUT to GND with a 0.1 $\mu$ F (min) capacitor.    |
| 14       | 14       | $\overline{\text{CEOUT}}$ | Active-Low Chip-Enable Output. $\overline{\text{CEOUT}}$ goes low only when $\overline{\text{CEIN}}$ is low and reset is not asserted. If $\overline{\text{CEIN}}$ is low when reset is asserted, $\overline{\text{CEOUT}}$ stays low for 12 $\mu$ s (typ) or until $\overline{\text{CEIN}}$ goes high, whichever occurs first.         |
| 15       | 15       | $\overline{\text{CEIN}}$  | Chip-Enable Input. The input to CE gating circuitry. Connect to GND or OUT if not used.                                                                                                                                                                                                                                                 |
| 16       | 16       | $V_{\text{CC}}$           | Supply Voltage Input. Bypass $V_{\text{CC}}$ to GND with a 0.1 $\mu$ F capacitor.                                                                                                                                                                                                                                                       |
| —        | —        | EP                        | Exposed Pad. Internally connected to GND. Connect EP to a large ground plane to aid heat dissipation. Do not use EP as the only ground connection for the device.                                                                                                                                                                       |

MAX16016/MAX16020/MAX16021

# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

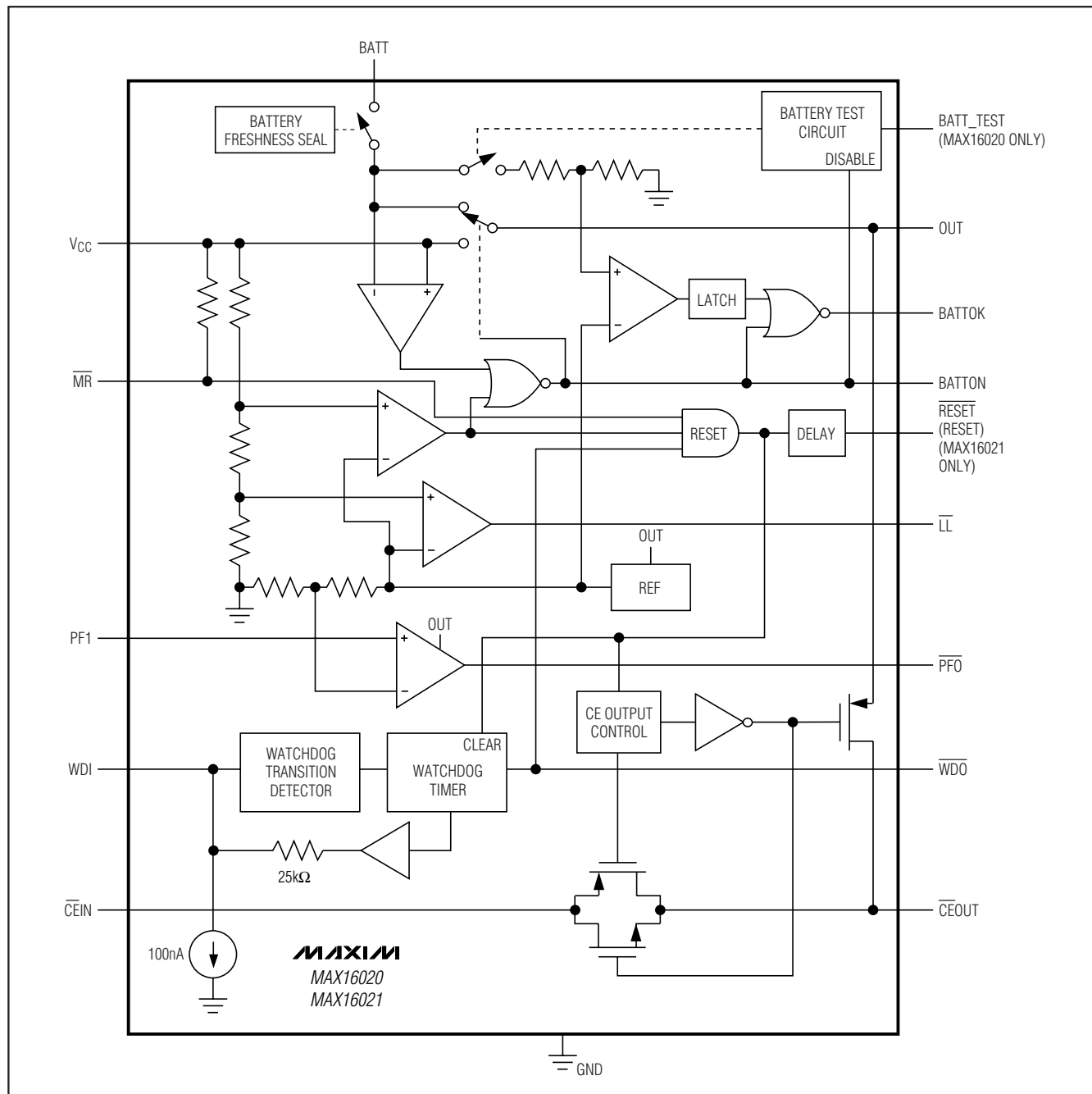
## Functional Diagrams



# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## Functional Diagrams (continued)

MAX16016/MAX16020/MAX16021



# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## Detailed Description

The *Typical Application Circuit* shows a typical connection using the MAX16020. OUT powers the static random-access memory (SRAM). If  $V_{CC}$  is greater than the reset threshold ( $V_{TH}$ ), or if  $V_{CC}$  is lower than  $V_{TH}$ , but higher than  $V_{BATT}$ ,  $V_{CC}$  connects to OUT. If  $V_{CC}$  is lower than  $V_{TH}$  and  $V_{CC}$  is less than  $V_{BATT}$ , BATT connects to OUT (see the *Functional Diagrams*). In battery-backup mode, an internal MOSFET connects the backup battery to OUT. The on-resistance of the MOSFET is a function of backup-battery voltage and temperature.

## Backup-Battery Switchover

In a brownout or power failure, it may be necessary to preserve the contents of the RAM. With a backup battery installed at BATT, the MAX16016/MAX16020/MAX16021 automatically switch the RAM to the backup power when  $V_{CC}$  falls. The MAX16016/MAX16020/MAX16021 have a BATTON output that goes high when in battery-backup mode. These devices require two conditions before switching to battery-backup mode:

- 1)  $V_{CC}$  must be below the reset threshold.
- 2)  $V_{CC}$  must be below  $V_{BATT}$ .

Table 3 lists the status of the inputs and outputs in battery-backup mode. The device does not power up if the only voltage source is on BATT. OUT only powers up from  $V_{CC}$  at startup.

## CE Signal Gating

The MAX16020/MAX16021 provide internal gating of CE signals to prevent erroneous data from being written to CMOS RAM in the event of a power failure or

brownout. During normal operation, the CE gate is enabled and passes all CE transitions. When the reset output asserts, this path becomes disabled, preventing erroneous data from corrupting the CMOS RAM.  $\overline{CEOUT}$  is pulled up to OUT through an internal current source. The 1.5ns propagation delay from  $\overline{CEIN}$  to  $\overline{CEOUT}$  allows the devices to be used with most  $\mu$ Ps and high-speed DSPs.

During normal operation (reset not asserted),  $\overline{CEIN}$  is connected to  $\overline{CEOUT}$  through a low on-resistance transmission gate. If  $\overline{CEIN}$  is high when a reset asserts,  $\overline{CEOUT}$  remains high regardless of any subsequent transition on  $\overline{CEIN}$  during the reset event.

If  $\overline{CEIN}$  is low when reset asserts,  $\overline{CEOUT}$  is held low for 12 $\mu$ s to allow completion of the read/write operation. After the 12 $\mu$ s delay expires,  $\overline{CEOUT}$  goes high and stays high regardless of any subsequent transitions on  $\overline{CEIN}$  during the reset event. When  $\overline{CEOUT}$  is disconnected from  $\overline{CEIN}$ ,  $\overline{CEOUT}$  is actively pulled up to OUT.

The propagation delay through the CE circuitry depends on both the source impedance of the drive to  $\overline{CEIN}$  and the capacitive loading at  $\overline{CEOUT}$ . Minimize the capacitive load at  $\overline{CEOUT}$  to minimize the propagation delay, and use a low output-impedance driver.

## Low-Line Output ( $\overline{LL}$ )

The low-line comparator monitors  $V_{CC}$  with a threshold voltage typically 2.5% higher than the reset threshold (see Table 2).  $\overline{LL}$  asserts prior to a reset condition during a brownout condition. On power-up,  $\overline{LL}$  deasserts after the reset output.  $\overline{LL}$  can be used to provide a nonmaskable interrupt (NMI) to the  $\mu$ P when the voltage begins to fall to initiate an orderly software shutdown routine.

## Manual Reset Input

Many  $\mu$ P-based products require manual reset capability, allowing the operator, a test technician, or external logic circuitry to initiate a reset. For the MAX16016/MAX16020/MAX16021, a logic-low on  $\overline{MR}$  asserts RESET/RESE $\overline{T}$ . RESET/RESE $\overline{T}$  remains asserted while  $\overline{MR}$  is low. When  $\overline{MR}$  goes high RESET/RESE $\overline{T}$  deasserts after a minimum of 145ms ( $t_{RP}$ ).  $\overline{MR}$  has an internal 30k $\Omega$  pullup resistor to  $V_{CC}$ .  $\overline{MR}$  can be driven with TTL/CMOS logic levels or with open-drain/collector outputs. Connect a normally open momentary switch from  $\overline{MR}$  to GND to create a manual reset function; external debounce circuitry is not required. If  $\overline{MR}$  is driven from a long cable or the device is used in a noisy environment, connect a 0.1 $\mu$ F capacitor from  $\overline{MR}$  to GND to provide additional noise immunity.

**Table 3. Input and Output Status in Battery-Backup Mode**

| PIN                       | STATUS                                                                                                                                      |
|---------------------------|---------------------------------------------------------------------------------------------------------------------------------------------|
| $V_{CC}$                  | Disconnected from OUT                                                                                                                       |
| OUT                       | Connected to BATT                                                                                                                           |
| BATT                      | Connected to OUT. Current drawn from the battery is less than 0.55 $\mu$ A (at $V_{BATT} = 3V$ , excluding $I_{OUT}$ ) when $V_{CC} = 0V$ . |
| RESET/RESE $\overline{T}$ | Asserted                                                                                                                                    |
| BATTON, $\overline{WDO}$  | High state (push-pull), high impedance (open-drain)                                                                                         |
| BATTOK, $\overline{LL}$   | Low state                                                                                                                                   |
| $\overline{CEIN}$         | Disconnected from $\overline{CEOUT}$                                                                                                        |
| $\overline{CEOUT}$        | Pulled up to $V_{OUT}$                                                                                                                      |
| $\overline{PFO}$          | Not affected                                                                                                                                |

# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## Watchdog Timer

### Watchdog Input

The watchdog monitors  $\mu$ P activity through the input WDI. If the  $\mu$ P becomes inactive, either the reset output is asserted in pulses (MAX16016) or the watchdog output goes low (MAX16020/MAX16021). To use the watchdog function, connect WDI to a bus line or  $\mu$ P I/O line. If WDI remains high or low for longer than the watchdog timeout period, the internal watchdog timer runs out and  $\overline{\text{RESET}}$  asserts for the reset timeout period (MAX16016) or  $\overline{\text{WDO}}$  goes low (MAX16020/MAX16021). The internal watchdog timer clears whenever the reset output asserts or the WDI sees a rising or falling edge within the watchdog timeout period. The WDI input is designed for a three-stated output device with a  $10\mu\text{A}$  maximum leakage current and the capability of driving a maximum capacitive load of  $200\text{pF}$ . The three-state device must be able to source and sink at least  $200\mu\text{A}$  when active. Disable the watchdog timer by leaving WDI unconnected or by three-stating the driver connected to WDI. The watchdog timer periodically attempts to pulse WDI to the opposite logic-level through a  $25\text{k}\Omega$  resistor for  $40\mu\text{s}$  to determine whether WDI is either unconnected or latched to a logic state. The watchdog function is also disabled when in battery-backup mode.

### Watchdog Output

$\overline{\text{WDO}}$  remains high if there is a transition or pulse at WDI during the watchdog-timeout period.  $\overline{\text{WDO}}$  goes low if no transition occurs at WDI during the watchdog timeout period and remains low until the next transition at WDI or when a reset is asserted. Connect  $\overline{\text{WDO}}$  to  $\overline{\text{MR}}$  to generate a system reset on every watchdog fault. When a

watchdog fault occurs in this mode,  $\overline{\text{WDO}}$  goes low, which pulls  $\overline{\text{MR}}$  low, causing a reset pulse to be issued. As soon as the reset output is asserted, the watchdog timer clears and  $\overline{\text{WDO}}$  returns high. With  $\overline{\text{WDO}}$  connected to  $\overline{\text{MR}}$ , a continuous high or low on WDI causes  $145\text{ms}$  (min) reset pulses to be issued every  $1.235\text{s}$ .

## Battery Testing Function/BATTOK Indicator (MAX16020/MAX16021)

The MAX16020/MAX16021 feature a battery testing function that works in conjunction with the BATTOK output. The battery voltage is tested for  $1.235\text{s}$  after  $V_{\text{CC}}$  is applied and once every 24 hours thereafter. During this test, an internal  $100\text{k}\Omega$  resistor is connected from BATT to ground and the battery is monitored to ensure that the battery voltage is above  $2.6\text{V}$ . If the battery voltage is below  $2.6\text{V}$ , the BATTOK output deasserts low to indicate a weak battery condition. The MAX16020 has a BATT\_TEST output that pulses high during the battery voltage test. Connect a resistor and FET as shown in Figure 6 to provide an additional load during the battery test. In battery-backup mode, the battery testing function is disabled and BATTOK goes low.

## Battery Freshness Seal Mode

The MAX16016/MAX16020/MAX16021 battery freshness seal disconnects the backup battery from internal circuitry and OUT until  $V_{\text{CC}}$  is applied. This ensures the backup battery connected to BATT is fresh when the final product is used for the first time.

The internal freshness seal latch prevents BATT from powering OUT until  $V_{\text{CC}}$  has come up for the first time, setting the latch. When  $V_{\text{CC}}$  subsequently turns off, BATT begins to power OUT.

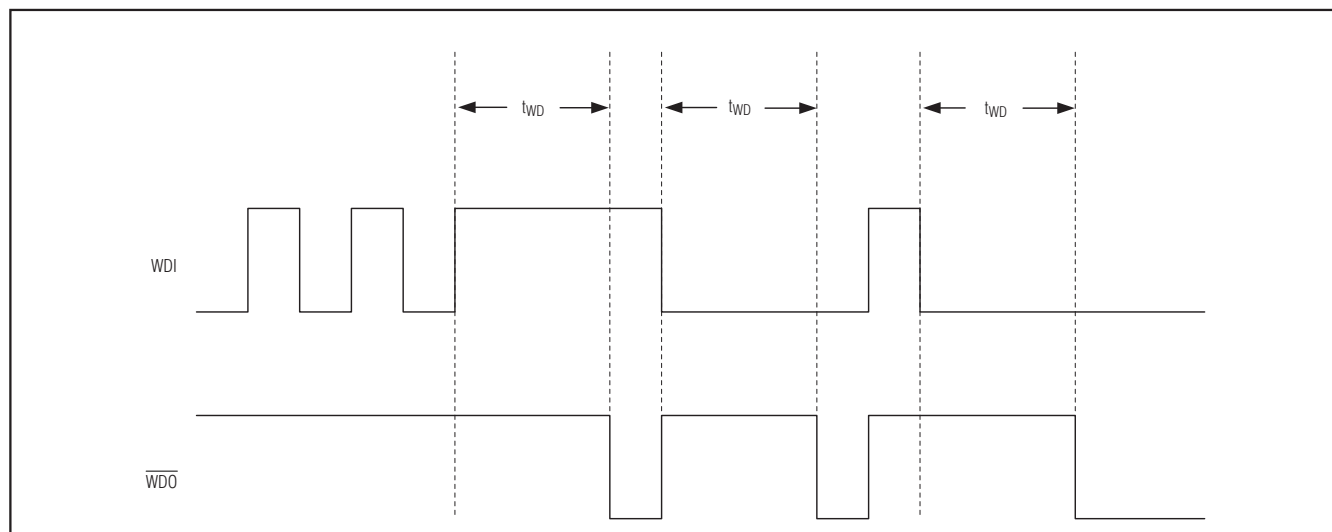


Figure 1. Watchdog Timing (MAX16016/MAX16020)

# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

To reenale the freshness seal:

- 1) Connect a battery to BATT.
- 2) Bring VCC to 0V.
- 3) Drive  $\overline{MR}$  higher than  $V_{BATT} + 1.2V$  for at least  $3\mu s$ .
- 4) Pull OUT to 0V.

## Reset Output

A  $\mu$ P's reset input starts the  $\mu$ P in a known state. The  $\mu$ P supervisory circuits assert a reset to prevent code-execution errors during power-up, power-down, and brownout conditions. Reset output is guaranteed to be a logic-low or logic-high depending on the device chosen.  $\overline{RESET}$  or RESET asserts when VCC is below the reset threshold and remains asserted for at least 145ms (tRP) after VCC rises above the reset threshold.  $\overline{RESET}$  or RESET also asserts when  $\overline{MR}$  is low. The MAX16016 watchdog function causes  $\overline{RESET}$  to assert in pulses following a watchdog timeout. The reset output is available in both push-pull and open-drain configurations.

## Power-Fail Comparator

The MAX16016/MAX16020/MAX16021 offer an under-voltage comparator that the output  $\overline{PFO}$  goes low when the voltage at PFI falls below its  $V_{PFT}$  threshold.

Common uses for the power-fail comparator include monitoring the power supply (such as a battery) before any voltage regulation to provide an early power-fail warning, so software can conduct an orderly system shutdown. The power-fail comparator has a typical input hysteresis of  $V_{PFT-HYS}$  and is powered from OUT, making it independent of the reset circuit. Connect the PFI input to GND if not used.

## Applications Information

### Monitoring an Additional Supply

The MAX16016/MAX16020/MAX16021  $\mu$ P supervisors can monitor either positive or negative supplies using a resistive voltage-divider to PFI.  $\overline{PFO}$  can be used to generate an interrupt to the  $\mu$ P or to trigger a reset (Figures 2 and 3). To monitor a negative supply, connect the top of the resistive divider to VCC. Connect the bottom of the resistive divider to the negative voltage to be monitored.

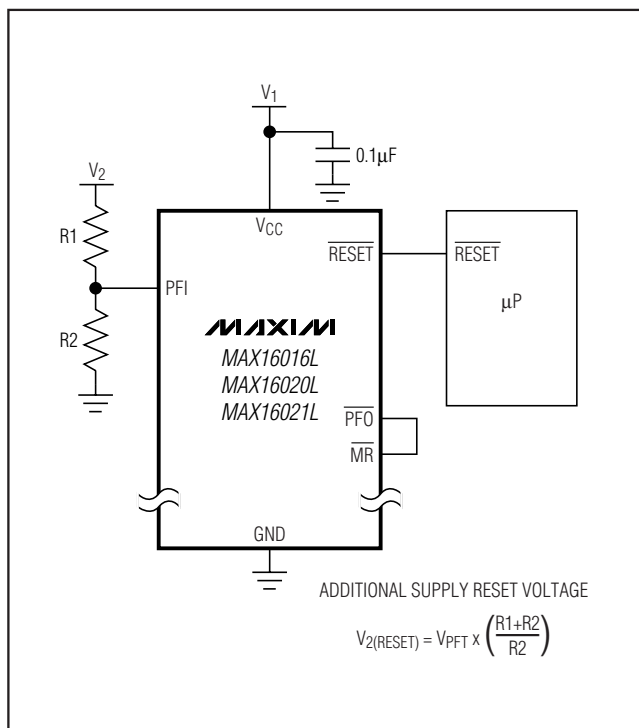


Figure 2. Monitoring an Additional Supply by Connecting  $\overline{PFO}$  to  $\overline{MR}$

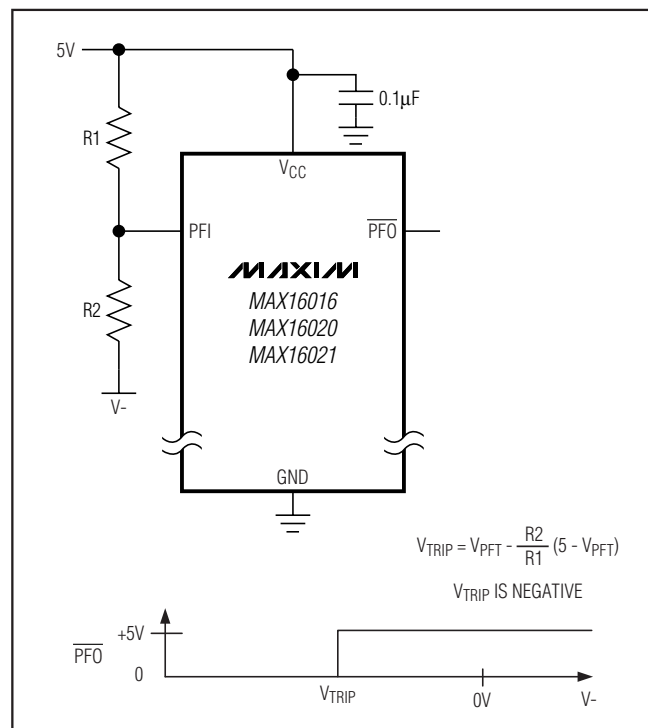


Figure 3. Monitoring a Negative Supply



# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## Adding Hysteresis to PFI

The power-fail comparators have a typical input hysteresis of  $V_{PFT-HYS}$ . This is sufficient for most applications where a power-supply line is being monitored through an external voltage-divider (see the *Monitoring an Additional Supply* section). Figure 4 shows how to add hysteresis to the power-fail comparator. Select the ratio of R1 and R2 so that PFI sees  $V_{PFT}$  when  $V_{IN}$  falls to the desired trip point ( $V_{TRIP}$ ). Resistor R3 adds hysteresis. R3 is typically an order of magnitude greater than R1 or R2. R3 should be larger than  $50k\Omega$  to prevent it from loading down  $\overline{PFO}$ . Capacitor C1 adds additional noise rejection.

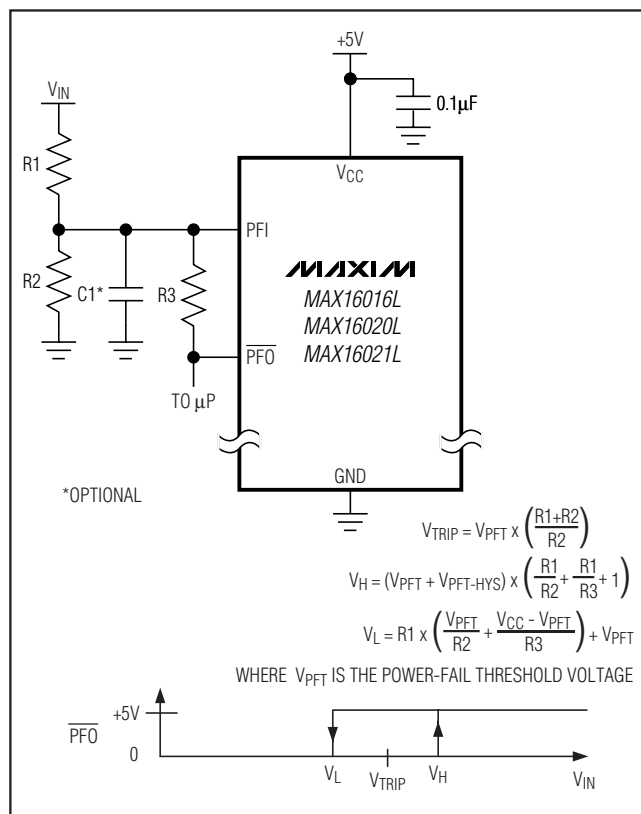


Figure 4. Adding Hysteresis to the Power-Fail Comparator

## Battery-On Indicator (Push-Pull Version)

BATTON goes high when in battery-backup mode. Use BATTON to indicate battery-switchover status or to supply base drive to an external pass transistor for higher current applications (Figure 5).

## Operation Without a Backup Power Source

The MAX16016/MAX16020/MAX16021 provide a battery-backup function. If a backup power source is not used, connect BATT to GND and OUT to  $V_{CC}$ .

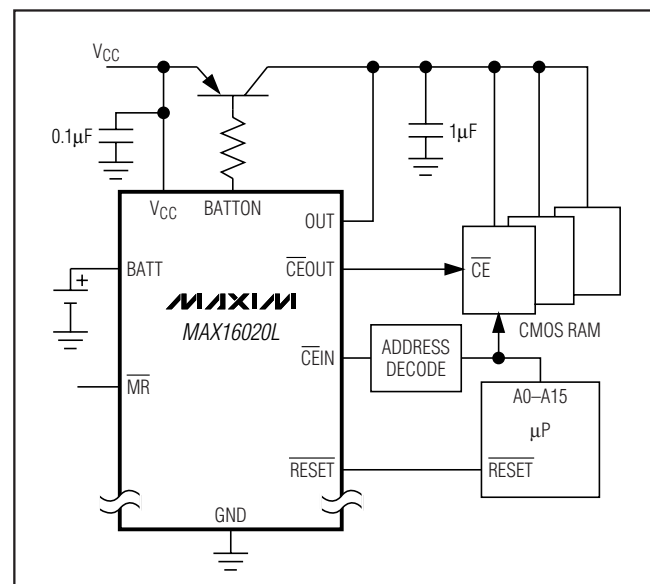


Figure 5. BATTON Driving an External Pass Transistor

## Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

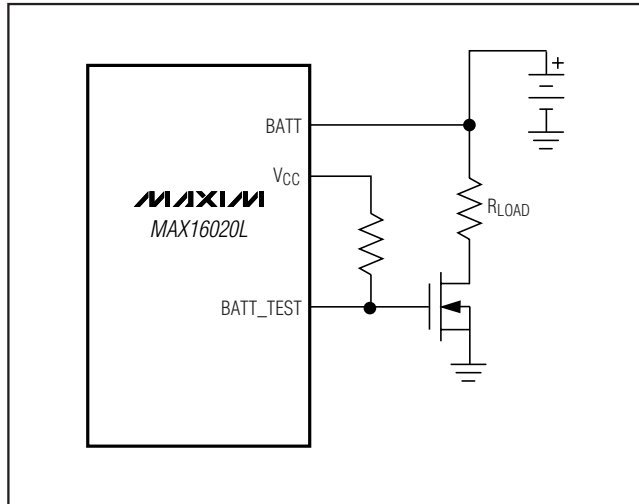


Figure 6. Adjustable BATT\_TEST Load

### Replacing the Backup Battery

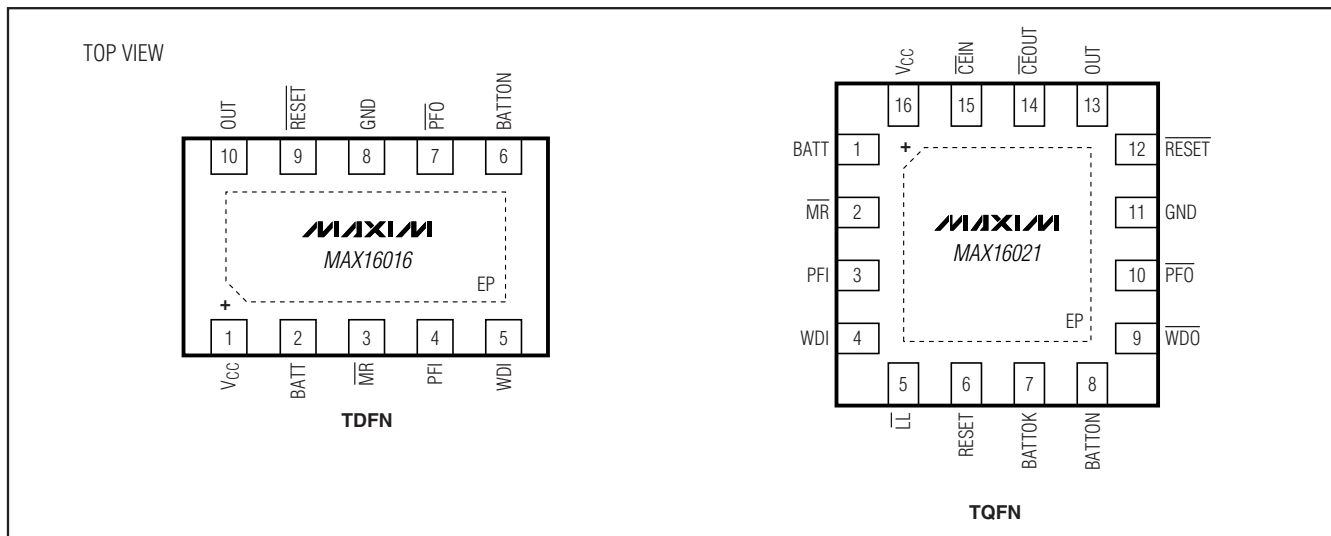
When  $V_{CC}$  is above  $V_{TH}$ , the backup power source can be removed without danger of triggering a reset pulse. The device does not enter battery-backup mode when  $V_{CC}$  stays above the reset threshold voltage.

### Negative-Going $V_{CC}$ Transients

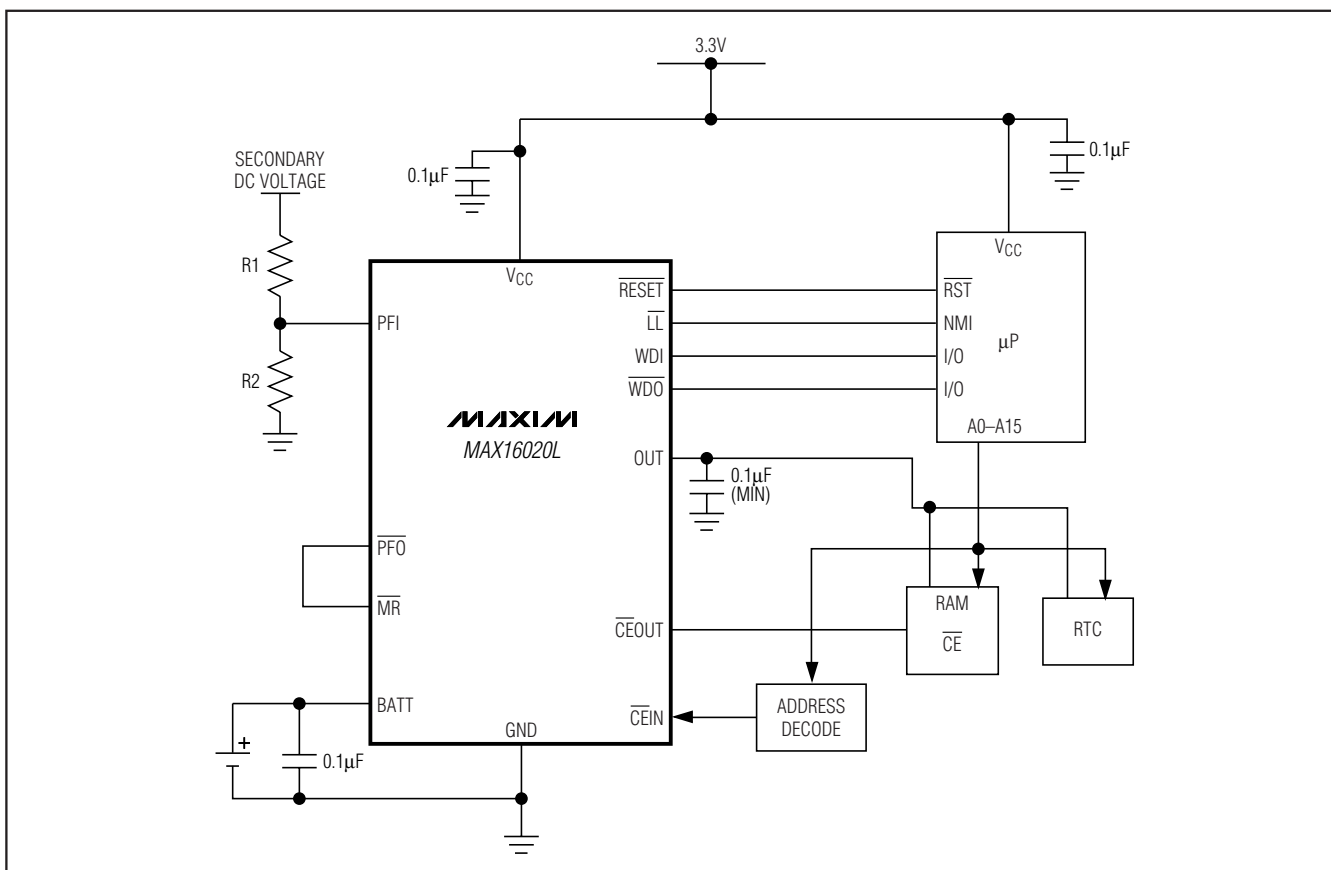
The MAX16016/MAX16020/MAX16021 are relatively immune to short duration, negative going  $V_{CC}$  transients. Resetting the  $\mu$ P when  $V_{CC}$  experiences only small glitches is usually not desirable. A 0.1 $\mu$ F bypass capacitor mounted close to  $V_{CC}$  provides additional transient immunity.

# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## Pin Configurations (continued)



## Typical Application Circuit



# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## Selector Guide

| PART         | ALL LOGIC OUTPUTS (EXCEPT BATT_TEST) | $\overline{\text{MR}}$ | POWER-FAIL COMPARATOR | WATCHDOG TIMER               | BATTON | LOW-LINE OUTPUT | BATTOK/<br>BATT_TEST/<br>RESET | CHIP-ENABLE |
|--------------|--------------------------------------|------------------------|-----------------------|------------------------------|--------|-----------------|--------------------------------|-------------|
| MAX16016LTB_ | Push-pull                            | ✓                      | ✓                     | WDI                          | ✓      | —               | —                              | —           |
| MAX16016PTB_ | Open-drain                           | ✓                      | ✓                     | WDI                          | ✓      | —               | —                              | —           |
| MAX16020LTE_ | Push-pull                            | ✓                      | ✓                     | WDI/ $\overline{\text{WDO}}$ | ✓      | ✓               | BATTOK/<br>BATT_TEST           | ✓           |
| MAX16020PTE_ | Open-drain                           | ✓                      | ✓                     | WDI/ $\overline{\text{WDO}}$ | ✓      | ✓               | BATTOK/<br>BATT_TEST           | ✓           |
| MAX16021LTE_ | Push-pull                            | ✓                      | ✓                     | WDI/ $\overline{\text{WDO}}$ | ✓      | ✓               | BATTOK/<br>RESET               | ✓           |
| MAX16021PTE_ | Open-drain                           | ✓                      | ✓                     | WDI/ $\overline{\text{WDO}}$ | ✓      | ✓               | BATTOK/<br>RESET               | ✓           |

## Ordering Information (continued)

| PART           | TEMP RANGE     | PIN-PACKAGE |
|----------------|----------------|-------------|
| MAX16020_TE_+T | -40°C to +85°C | 16 TQFN-EP* |
| MAX16021_TE_+T | -40°C to +85°C | 16 TQFN-EP* |

The first placeholder “\_” designates all output options. Letter “L” indicates push-pull outputs and letter “P” indicates open-drain outputs. The last placeholder “\_” designates the reset threshold (see Table 1).

T = Tape and reel.

+Denotes a lead(Pb)-free/RoHS-compliant package.

\*EP = Exposed pad.

## Chip Information

PROCESS: BiCMOS

## Package Information

For the latest package outline information and land patterns (footprints), go to [www.maxim-ic.com/packages](http://www.maxim-ic.com/packages). Note that a “+”, “#”, or “-” in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE TYPE | PACKAGE CODE | OUTLINE NO.             | LAND PATTERN NO.        |
|--------------|--------------|-------------------------|-------------------------|
| 10 TDFN-EP   | T1033+1      | <a href="#">21-0137</a> | <a href="#">90-0093</a> |
| 16 TQFN-EP   | T1644+4      | <a href="#">21-0139</a> | <a href="#">90-0070</a> |

# Low-Power $\mu$ P Supervisory Circuits with Battery-Backup Circuit and Chip-Enable Gating

## Revision History

| REVISION NUMBER | REVISION DATE | DESCRIPTION                                                                                                                                                                 | PAGES CHANGED                             |
|-----------------|---------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------|
| 0               | 5/08          | Initial release                                                                                                                                                             | —                                         |
| 1               | 7/08          | Released the MAX16016. Updated <i>Ordering Information</i> , <i>Electrical Characteristics</i> , Tables 1 and 2, <i>Pin Description</i> , and <i>Detailed Description</i> . | 1, 3, 4, 5, 9, 10, 12, 13, 15, 16, 19, 20 |
| 2               | 10/08         | Released the MAX16021.                                                                                                                                                      | 20                                        |
| 3               | 12/08         | Updated <i>Electrical Characteristics</i> , <i>Pin Description</i> , Table 3, and the <i>Power-Fail Comparator</i> section.                                                 | 3, 9, 10, 11, 14, 16                      |
| 4               | 1/10          | Updated <i>Electrical Characteristics</i> .                                                                                                                                 | 4                                         |
| 5               | 4/11          | Updated <i>Pin Description</i> .                                                                                                                                            | 9, 10                                     |
| 6               | 11/11         | Updated <i>Pin Description</i> .                                                                                                                                            | 9, 10                                     |

MAX16016/MAX16020/MAX16021

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time. The parametric values (min and max limits) shown in the Electrical Characteristics table are guaranteed. Other parametric values quoted in this data sheet are provided for guidance.

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